

February 1984 Revised July 2003

## MM74HC4514 4-to-16 Line Decoder with Latch

#### **General Description**

The MM74HC4514 utilizes advanced silicon-gate CMOS technology, which is well suited to memory address decoding or data routing application. It possesses high noise immunity and low power dissipation usually associated with CMOS circuitry, yet speeds comparable to low power Schottky TTL circuits. It can drive up to 10 LS-TTL loads.

The MM74HC4514 contain a 4-to-16 line decoder and a 4-bit latch. The latch can store the data on the select inputs, thus allowing a selected output to remain HIGH even though the select data has changed. When the LATCH ENABLE input to the latches is HIGH the outputs will change with the inputs. When LATCH ENABLE goes LOW the data on the select inputs is stored in the latches. The four select inputs determine which output will go HIGH provided the INHIBIT input is LOW. If the INHIBIT input is HIGH all outputs are held LOW thus disabling the decoder.

The MM74HC4514 is functionally and pinout equivalent to the CD4514BC and the MC1451BC. All inputs are protected against damage due to static discharge diodes from  $\rm V_{CC}$  and ground.

#### **Features**

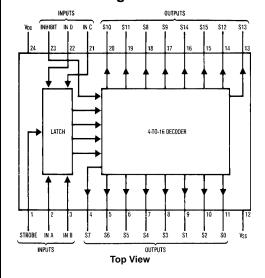
- Typical propagation delay: 18 ns
- Low quiescent power: 80 µA maximum (74HC Series)
- Low input current: 1 µA maximum
- Fanout of 10 LS-TTL loads (74HC Series)

### **Ordering Code:**

Order Number	Package Number	Package Description
MM74HC4514WM	M24B	24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
MM74HC4514MTC	MTC24	24-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HC4514N	N24C	24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

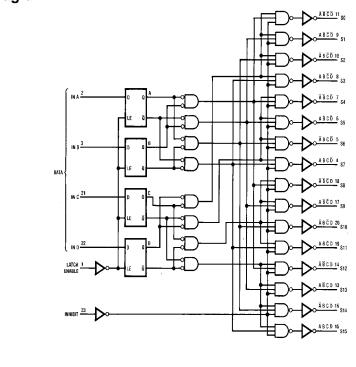
# **Connection Diagram**



### **Truth Table**

		Data Inputs				
LE	Inhibit	D	С	В	Α	Selected Output High
Н	L	L	L	L	L	S0
Н	L	L	L	L	Н	S1
Н	L	L	L	Н	L	S2
Н	L	L	L	Н	Н	S3
Н	L	L	Н	L	L	S4
Н	L	L	Н	L	Н	S5
Н	L	L	Н	Н	L	S6
Н	L	L	Н	Н	Н	S7
Н	L	Н	L	L	L	S8
Н	L	Н	L	L	Н	S9
Н	L	Н	L	Н	L	S10
Н	L	Н	L	Н	Н	S11
Н	L	Н	Н	L	L	S12
Н	L	Н	Н	L	Н	S13
Н	L	Н	Н	Н	L	S14
Н	L	Н	Н	Н	Н	S15
						All
Х	Н	Χ	Х	Χ	Х	Outputs = 0
						Latched
L	L	Х	Χ	Х	Х	Data

# Logic Diagram



## **Absolute Maximum Ratings**(Note 1)

(Note 2)

Supply Voltage (V <sub>CC</sub> )	-0.5 to $+7.0$ V
DC Input Voltage (V <sub>IN</sub> )	$-1.5$ to $V_{CC} + 1.5V$
DC Output Voltage (V <sub>OUT</sub> )	$-0.5$ to $V_{CC}$ $+0.5V$
Clamp Diode Current (I <sub>IK</sub> , I <sub>OK</sub> )	±20 mA
DC Output Current, per pin (I <sub>OUT</sub> )	±25 mA
DC $V_{CC}$ or GND Current, per pin ( $I_{CC}$ )	±50 mA
Storage Temperature Range (T <sub>STG</sub> )	-65°C to +150°C
Power Dissipation (P <sub>D</sub> )	
(Note 3)	600 mW
S.O. Package only	500 mW
Lead Temperature (T <sub>I</sub> )	

# Recommended Operating Conditions

	Min	Max	Units						
Supply Voltage (V <sub>CC</sub> )	2	6	V						
DC Input or Output Voltage	0	$V_{CC}$	V						
$(V_{IN}, V_{OUT})$									
Operating Temperature Range (T <sub>A</sub> )	-40	+85	°C						
Input Rise or Fall Times									
$(t_{r}, t_{f}) V_{CC} = 2.0V$		1000	ns						
$V_{CC} = 4.5V$		500	ns						
$V_{CC} = 6.0V$		400	ns						
Note 1: Maximum Ratings are those values beyond which damage to the									

device may occur.

Note 2: Unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: –

12 mW/°C from 65°C to 85°C.

### DC Electrical Characteristics (Note 4)

(Soldering 10 seconds)

Symbol	Parameter	Conditions	v <sub>cc</sub>	T <sub>A</sub> = 25°C		$T_A = -40 \text{ to } 85^{\circ}\text{C}$	T <sub>A</sub> = -55 to 125°C	Units
Cymbol			•66	Тур		Guaranteed Limits		Onits
V <sub>IH</sub>	Minimum HIGH Level		2.0V		1.5	1.5	1.5	
	Input Voltage		4.5V		3.15	3.15	3.15	V
			6.0V		4.2	4.2	4.2	
V <sub>IL</sub>	Maximum LOW Level		2.0V		0.5	0.5	0.5	
	Input Voltage		4.5V		1.35	1.35	1.35	V
			6.0V		1.8	1.8	1.8	
V <sub>OH</sub>	Minimum HIGH Level	$V_{IN} = V_{IH}$ or $V_{IL}$	2.0V	2.0	1.9	1.9	1.9	
	Output Voltage	$ I_{OUT}  \le 20 \mu A$	4.5V	4.5	4.4	4.4	4.4	V
			6.0V	6.0	5.9	5.9	5.9	
		$V_{IN} = V_{IH}$ or $V_{IL}$						
		$ I_{OUT}  \le 4.0 \text{ mA}$	4.5V	4.2	3.98	3.84	3.7	V
		$ I_{OUT}  \le 5.2 \text{ mA}$	6.0V	5.7	5.48	5.34	5.2	
V <sub>OL</sub>	Maximum LOW Level	$V_{IN} = V_{IH}$ or $V_{IL}$	2.0V	0	0.1	0.1	0.1	
	Output Voltage	$ I_{OUT}  \le 20 \mu A$	4.5V	0	0.1	0.1	0.1	V
			6.0V	0	0.1	0.1	0.1	
		$V_{IN} = V_{IH}$ or $V_{IL}$						
		$ I_{OUT}  \le 4.0 \text{ mA}$	4.5V	0.2	0.26	0.33	0.4	V
		$ I_{OUT}  \le 5.2 \text{ mA}$	6.0V	0.2	0.26	0.33	0.4	
I <sub>IN</sub>	Maximum Input Current	$V_{IN} = V_{CC}$ or GND	6.0V		±0.1	±1.0	±1.0	μΑ
I <sub>CC</sub>	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND $I_{OUT} = 0 \mu A$	6.0V		8.0	80	160	μА

260°C

Note 4: For a power supply of 5V ±10% the worst case output voltages (V<sub>OH</sub>, and V<sub>OL</sub>) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V<sub>IH</sub> and V<sub>IL</sub> occur at V<sub>CC</sub> = 5.5V and 4.5V respectively. (The V<sub>IH</sub> value at 5.5V is 3.85V.) The worst case leakage current (I<sub>IN</sub>, I<sub>CC</sub>, and I<sub>OZ</sub>) occur for CMOS at the higher voltage and so the 6.0V values should be used.

### **AC Electrical Characteristics**

 $V_{CC} = 5V, T_A = 25^{\circ}C, C_L = 15 \text{ pF, } t_r = t_f = 6 \text{ ns}$ 

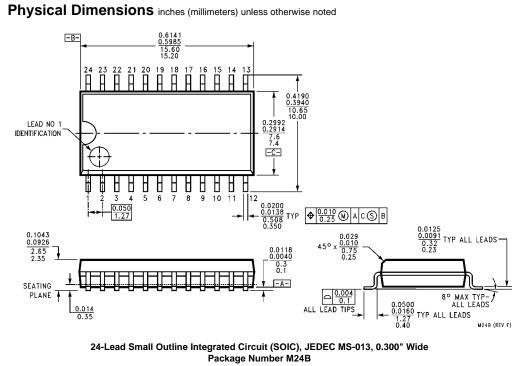
Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Units	
t <sub>PHL</sub> , t <sub>PLH</sub>	Maximum Propagation Delay Data to Output		18	30	ns	
t <sub>PHL</sub>	Maximum Propagation Delay LE to Output		18	30	ns	
t <sub>PLH</sub>	Maximum Propagation Delay LE to Output		24	40	ns	
t <sub>PHL</sub>	Maximum Propagation Delay Inhibit to Output		16	30	ns	
t <sub>PLH</sub>	Maximum Propagation Delay Inhibit to Output		24	40	ns	
t <sub>s</sub>	Minimum Setup Time, Date to LE			20	ns	
t <sub>H</sub>	Minimum Hold Time, LE to Data			5	ns	
t <sub>W</sub>	Minimum Pulse Width, Latch Enable			16	ns	

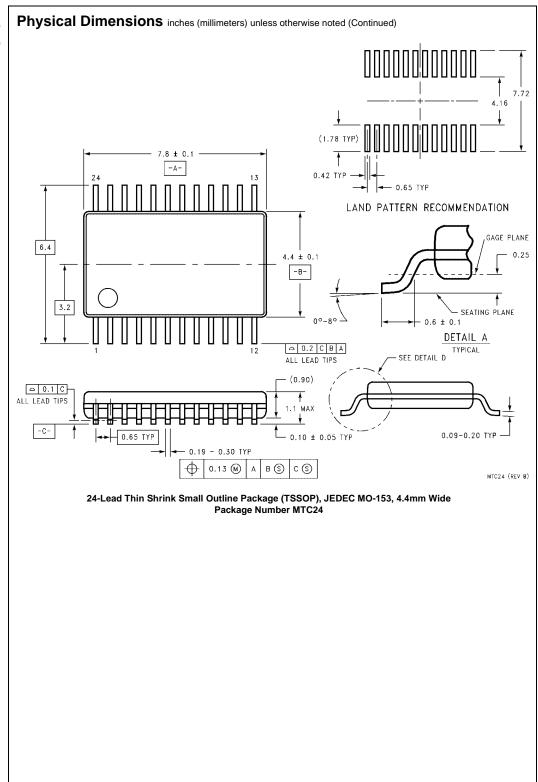
#### **AC Electrical Characteristics**

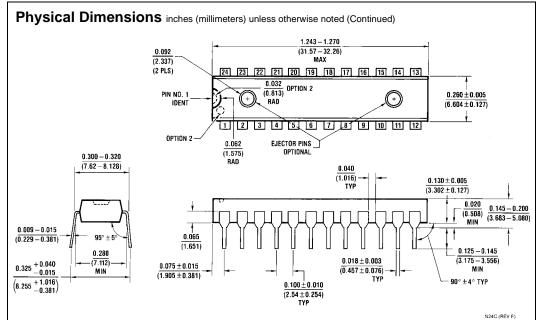
 $\mbox{V}_{CC} = 2.0\mbox{V} - 6.0\mbox{V}, \ \mbox{C}_L = 50 \ \mbox{pF}, \ t_r = t_f = 6 \ \mbox{ns}$  (unless otherwise specified)

Symbol	Parameter	Conditions	v <sub>cc</sub>	T <sub>A</sub> = 25°C		T <sub>A</sub> = -40 to 85°C	$T_A = -55$ to $125^{\circ}C$	Units
Cyllibol				Тур	Typ Guaranteed Limits		imits	Oille
t <sub>PHL</sub> , t <sub>PLH</sub>	Maximum Propagation		2.0V	80	175	220	263	
	Delay Data to Output		4.5V	18	35	44	53	ns
			6.0V	16	30	38	45	
t <sub>PHL</sub>	Maximum Propagation		2.0V	80	175	220	263	
	Delay LE to Output		4.5V	19	35	44	53	ns
			6.0V	17	30	38	45	
t <sub>PLH</sub>	Maximum Propagation		2.0V	120	230	290	343	
	Delay LE to Output		4.5V	27	46	58	69	ns
			6.0V	22	39	49	58	
t <sub>PHL</sub>	Maximum Propagation		2.0V	70	175	220	263	
=	Delay Inhibit to Output		4.5V	18	35	44	53	ns
			6.0V	16	30	38	45	
t <sub>PLH</sub>	Maximum Propagation		2.0V	120	230	290	343	
	Delay Inhibit to Output		4.5V	27	46	58	69	ns
			6.0V	22	39	49	58	
t <sub>s</sub>	Minimum Setup Time,		2.0V		100	125	150	
	Data to LE		4.5V		20	25	30	ns
			6.0V		17	21	25	
t <sub>H</sub>	Minimum Hold Time,		2.0V		5	5	5	
	LE to Data		4.5V		5	5	5	ns
			6.0V		5	5	5	
t <sub>W</sub>	Minimum Pulse Width,		2.0V		80	100	120	
	Latch Enable		4.5V		16	20	24	ns
			6.0V		14	17	20	
C <sub>PD</sub>	Power Dissipation			000				
	Capacitance (Note 5)			290				pF
C <sub>IN</sub>	Maximum Input			_	40	40	40	
	Capacitance			5	10	10	10	pF

Note 5:  $C_{PD}$  determines the no load dynamic power consumption,  $P_D = C_{PD} \ V_{CC}^2 \ f + I_{CC} \ V_{CC}$ , and the no load dynamic current consumption,  $I_S = C_{PD} \ V_{CC} \ f + I_{CC}$ .







24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N24C

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